

Unbuffered Memory Module Data Sheet

Imagem meramente ilustrativa

MW01GN1037SA8 / MW01GN1339SA8

1 GByte, DDR3, PC3-8500 (1066 MHz) CL7/ PC3-10600 (1333 MHz) CL9, 204 Pin unbuffered SO-DIMM

Description:

MW01GN1037SA8 and **MW01GN1339SA8** are 1 Gigabyte Memory Modules, organized as 128Mx64 bits DDR3-SDRAM. The modules are composed by eight 128Mx8 DDR3-SDRAMs ICs in FBGA package and one serial EEPROM for SPD (Serial Presence Detect), mounted on a JEDEC-Standard 204-pin SO-DIMM (Small Outline Dual In Line Memory Module) with golden contacts.

Features:

- 204 Pin SO-DIMM outline, unbuffered;
- Single Bank modules - Using 128Mx8 DDR3 SDRAMs;
- Double Data Rate DDR3 architecture; two data transfers per clock cycle;
- On-Die Termination Control (ODT);
- Differential clock inputs;
- Burst length (BL): 8 and 4 with Burst Chop (BC);
- Clock Cycle Time (t_{CK} avg)
 - MW01GN1037SA8: 1.875 ns @ CL=7
 - MW01GN1339SA8: 1.50 ns @ CL=9
- EEPROM Serial Presence Detection (SPD);
- Bidirectional, differential data strobe (DQS and /DQS);
- Eight internal device banks for concurrent operation;
- Refresh to Active (t_{RFC}): 110 ns (min.);
- Auto precharge option for each burst access;
- Auto-refresh and Self-refresh modes;
- Row addressing: $A_0 \sim A_{13}$;
- Column addressing: $A_0 \sim A_9$;
- Bank addressing: $BA_0 \sim BA_2$;
- SSTL_15 interface: $V_{DD} = 1.5 V \pm 0.075 V$;
- Refresh period: (see note 6 below):
 - $0^\circ C \leq TC \leq +85^\circ C$: 7.8 μs
 - $+85^\circ C < TC \leq +95^\circ C$: 3.9 μs

DC Characteristics:

($TC=0^\circ C$ to $+85^\circ C$, V_{DD} , $V_{DDQ} = 1.5V \pm 0.075V$)

Parameter	Symbol	MW01GN1037SA8	MW01GN1339SA8	Unit	Notes
		max.	max.		
Operating Current (ACT=PRE)	IDD0	800	944	mA	
Operating Current (ACT-READ-PRE)	IDD1	960	1104	mA	
Precharge Power Down Standby Current	IDD2P1	280	320	mA	Fast PD exit Slow PD exit
	IDD2P0	96	96	mA	
Precharge Quiet Standby Current	IDD2Q	424	480	mA	
Precharge Standby Current	IDD2N	440	520	mA	
Active Power-Down Current	IDD3P	280	320	mA	Always Fast exit
Active Standby Current	IDD3N	456	496	mA	
Operating Current	IDD4R	1280	1600	mA	Burst Read operating Burst Write operating
	IDD4W	1520	1760	mA	
Burst refresh Current	IDD5B	1760	1920	mA	

AC Characteristics:

($TC=0^\circ C$ to $+85^\circ C$, V_{DD} , $V_{DDQ} = 1.5V \pm 0.075V$, V_{SS} , $V_{SSQ} = 0V$)

Parameter	MW01GN1037UA8		MW01GN1339SA8		Unit (Notes)
	min.	max.	min.	max.	
tAA	13.91	20	13.91	20	ns
tWR	15	-	15	-	ns
tRCD	13.125	-	13.5	-	ns
tRRD	7.5	-	6	-	ns
	4	-	4	-	nCK
tRP	13.125	-	13.5	-	ns
tRAS	37.5	9 x tREFI	36	9 x tREFI	ns (7)
tRC	50.625	-	49.5	-	ns
tRFC	110	-	110	-	ns
tWTR	7.5	-	7.5	-	ns
	4	-	4	-	nCK
tRTP	7.5	-	7.5	-	ns
	4	-	4	-	nCK
tREFI	-	7.8	-	7.8	μs (6, 7)
tREFI $+85^\circ C \leq TC \leq +95^\circ C$	-	3.9	-	3.9	μs (6, 7)

Recommended DC Operating Conditions:

($TC = 0^\circ C$ to $+85^\circ C$)⁶

Parameter	Symbol	minimum	typical	maximum	Unit	Notes
Supply Voltage	VDD, VDDQ	1.425	1.5	1.575	V	1,2,3
	VSS	0	0	0	V	1
	VDDSPD	3.0	3.3	3.6	V	
Input Reference Voltage	VREFCA (DC)	0.49 x VDD	0.50 x VDD	0.51 x VDD	V	1, 4, 5
Input Reference Voltage for DQ	VREFDQ (DC)	0.49 x VDDQ	0.50 x VDDQ	0.51 x VDDQ	V	1, 4, 5

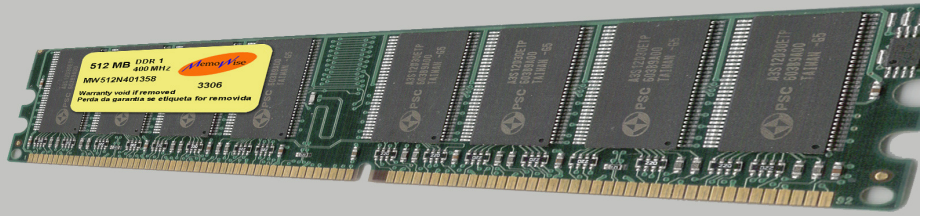
Notes:

1. DDR3 SDRAM Component Specification
2. Under all conditions VDDQ must be less than or equal to VDD.
3. VDDQ tracks with VDD. AC parameters are measured with VDD and VDDQ tied together
4. The AC peak noise on VREF may not allow VREF to deviate from VREF (DC) by more than $\pm 1\%$ VDD (for reference: approx. ± 15 mV)
5. For reference: approx. $V_{DD}/2 \pm 15$
6. When operating in the Range $+85^\circ C \sim +95^\circ C$ (TC = temperature of the DRAM ICs case) the following must be observed:
 - a. Refresh commands must be issued at double frequency, thus tREF must be lowered to 3.9 μs
 - b. If Self-Refresh must be used, it is mandatory to either use Manual Self-Refresh with Extended Temperature Range Capability (MR2 bits [A6, A7] = [0, 1]) or Auto Self Refresh Mode must be enabled (MR2 bits [A6, A7] = [1, 0]).
7. tREFI depends on operating case temperature (TC)

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WARNING: DO NOT USE IN LIFE SUPPORT

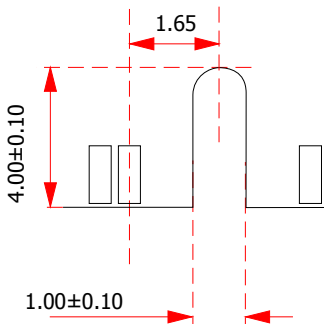
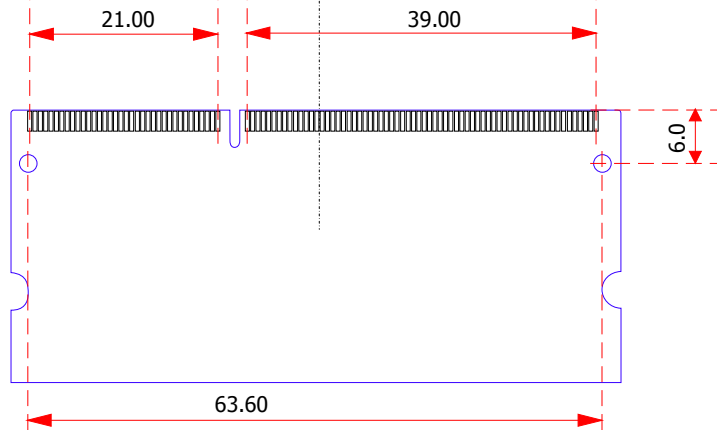
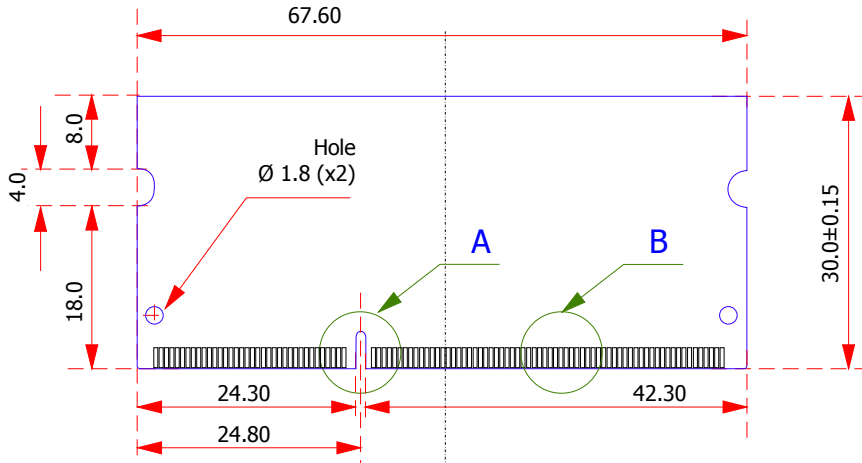
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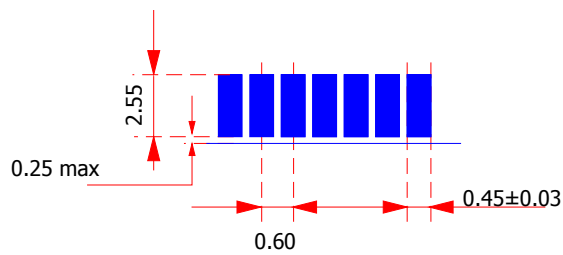
Unbuffered Memory Modules Data Sheet - **MW01GN1038SA8 / MW01GN1339SA8**

Dimensions

All dimensions are in millimeters
Tolerance is $\pm 0.1\text{mm}$ unless otherwise indicated



DETAIL A



DETAIL B

